| Additional name of conveying party(ies) attached? Yes No Interpretation | Name and address of receiving party(ies) Image: UCB CHIP Inc. Im |
|---|--|
| Tab settings ⇒ ⇒ ▼ | Record the attached original documents or copy thereof. Name and address of receiving party(ies) Imme: UCB CHIP Inc. Immerial Address: Imperent Address: Imperen |
| To the Director of the U.S. Patent and requested Piece: Please 1. Name of conveying party(ies): 5 - 2 - 0 3 Solutia Inc. Additional name of conveying party(ies) attached? Yes No 1. Nature of conveying party(ies) attached? Yes No 3. Nature of conveyance: | Name and address of receiving party(ies) ame: UCB CHIP Inc. ernal Address: reet Address: 300 Delaware Avenue, Suite 297 ty: Wilmington State: DE Zip: 1980 ditional Name(s) & address(es) attached? e execution date of the application is: B. Patent No.(s) 4,517,327 |
| Additional name of conveying party(ies) attached? Yes No | reet Address: 300 Delaware Avenue, Suite 297 ty: Wilmington State: DE Zip: 1980 Iditional Name(s) & address(es) attached? Pe execution date of the application is: B. Patent No.(s) 4,517,327 |
| Additional name of conveying party(ies) attached? Yes No | reet Address: 300 Delaware Avenue, Suite 297 ty: Wilmington State: DE Zip: 1980 Iditional Name(s) & address(es) attached? Pe execution date of the application is: B. Patent No.(s) 4,517,327 |
| 3. Nature of conveyance: Assignment | reet Address: 300 Delaware Avenue, Suite 297 ty: Wilmington State: DE Zip: 1980 ditional Name(s) & address(es) attached? Per execution date of the application is: B. Patent No.(s) 4,517,327 |
| Assignment | e execution date of the application is: B. Patent No.(s) 4,517,327 |
| Assignment | e execution date of the application is: B. Patent No.(s) 4,517,327 |
| Security Agreement Change of Name Other Execution Date: January 31, 2003 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the A. Patent Application No.(s) 10/075,438 08/954,880 09/768,408 Additional numbers attache 5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Janelle D. Strode 7. | e execution date of the application is: B. Patent No.(s) 4,517,327 |
| Execution Date: January 31, 2003 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the A. Patent Application No.(s) 10/075,438 08/954,880 09/768,408 Additional numbers attache 5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Janelle D. Strode 7. | e execution date of the application is: B. Patent No.(s) 4,517,327 |
| Execution Date: January 31, 2003 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the A. Patent Application No.(s) 10/075,438 08/954,880 09/768,408 Additional numbers attache 5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Janelle D. Strode 7. | e execution date of the application is: B. Patent No.(s) 4,517,327 |
| 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the A. Patent Application No.(s) 10/075,438 08/954,880 09/768,408 Additional numbers attache 5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Janelle D. Strode 7. | B. Patent No.(s) 4,517,327 |
| 5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Janelle D. Strode 7. | 4,554,319 4,590,101 |
| concerning this document should be mailed: Name: Janelle D. Strode 7. | |
| | Total number of applications and patents involved: 36 |
| Internal Address: LATHROP & GAGE L.C. | Total fee (37 CFR 3.41) \$ 1440 |
| | ☐ Enclosed |
| | Authorized to be charged to deposit account |
| | Deposit account number: |
| Street Address: 2345 Grand Boulevard Suite 2300 | 12-0600 |
| City: Kansas City State: MO Zip: 64108-2618 (A | ttach duplicate copy of this page if paying by deposit acco |
| DO NOT USE TH | S SPACE |
| | |
| 9. Statement and signature. | |
| To the best of my knowledge and belief, the foregoing information | rris true and correct and any attached copy |
| is a true copy of the original document. Janelle D. Strode | May 2, 2003 |
| | |
| Total number of pages including cover | ature Date |
| Mail documents to be recorded with requ | |
| 03 ECOOPER 00000255 120600 10075438 mm ssioner of Patents & Trader Washington, D.C. | sheet, attachments, and documents: 8 |

RECORDATION FORM COVER SHEET PATENTS ONLY CONTINUATION PAGE

Box 4: Application number(s) or patent number(s):

| A. Patent Application No.(s) | B. Patent No.(s) |
|------------------------------|------------------|
| 09,783,233 | 4,582,894 |
| 10/118,811 | 4,971,881 |
| 10/142,455 | 4,900,759 |
| 10/154,081 | 4,931,536 |
| 60/413,846 | 4,931,537 |
| 60/413,786 | 4,861,650 |
| 09/886,729 | 5,003,066 |
| 09/885,198 | 5,281,674 |
| 10/272,409 | 5,234,969 |
| | 5,288,523 |
| | 5,624,599 |
| | 5,621,059 |
| | 5,672,579 |
| | 6,465,582 |
| | 6,117,488 |
| | 6,391,984 |
| | 6,331,582 |
| | 5,225,470 |
| | 6,037,430 |
| | 5,599,872 |
| | 6,066,394 |

ASSIGNMENT

WHEREAS, Solutia Inc., a corporation duly organized under the laws of the State of Delaware and having its principal place of business at 575 Maryville Centre Drive, St. Louis, Missouri 63166, is the owner by assignment of certain Letters Patent (hereinafter "The Patent"), the particulars of which are set forth in patent applications or issued patents identified in Schedule A, attached hereto, or otherwise are identified in Schedule A; and

WHEREAS, UCB CHIP Inc., a corporation duly organized under the laws of the State of Delaware and having its principal place of business at 300 Delaware Avenue, Suite 1297, Wilmington, Delaware 19801, is desirous of acquiring interest to and under said inventions, said patents, and any and all additional Letters Patent which may be granted for or upon said inventions in the United States of America and all countries foreign thereto.

NOW THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Solutia Inc. has sold, assigned and transferred, and by these presents does sell, assign and transfer unto the said UCB CHIP Inc. the full and exclusive right, title and interest, throughout the world, in, to and under the following:

- (a) said invention(s) as set forth and described in the specifications of said issued patents;
- (b) any and all Letters Patent of the Untied States of America identified in Schedule A and any and all refilings, divisions, continuations and continuations-in-part thereof;
- (c) any and all reissues and reexaminations of said Letters Patent of the United States of America;
- (d) any and all applications for Letters Patent upon said invention(s) and/or applications that have been filed or hereafter may be filed in any and all countries foreign to the United States of America, including said applications identified in Schedule A, if any;

- (e) any and all refilings, divisions and continuations of said foreign-filed applications;
- (f) any and all Letters Patent of countries foreign to the United States of America that may issue or have issued from said foreign-filed applications, refilings, divisions and continuations, including said issued patents identified in Schedule A, if any; and
- (g) any and all extensions of, and additions to, said Letters Patent of the United States of America and of countries foreign to the United States of America.

ALL of the above shall be held and enjoyed by said UCB CHIP Inc. for its own use and benefit, and for its successors, legal representatives and assigns, to the full end of the term for which said Letters Patent may be granted, and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the said Letters Patent in accordance with this Assignment.

| Executed this | $31^{\frac{5}{2}}$ day of | Jamas | , 2003. |
|---------------|---------------------------|-------|---------|
| | • | | |

SOLUTIA INC.

Mark f: Wachter
General Intellectual Property Counsel
Authorized to sign this document for
Solutio Inc. by resolution dated
September 3, 1997 of the Board of Directors

| | 22.1 | 67 | 9 | elit | |
|--------|---|-----------------|---|-----------------------|--|
| Name:_ | aye | - T· | | | |
| Title: | *************************************** | | | VIII vestavas likitas | |

UCB CHIP INC.

Name: J. Van Caenegem V.L. Garrett

Title: Director Director

SCHEDULE A

Patent No.

4,554,319

4,590,101

4,517,327

| A maliantian Ma | 1 | | |
|------------------|------------|-------------|---|
| Application INO. | Issue Date | Filing Date | Title |
| 06/5/4,238 | 05/14/85 | 01/26/84 | Low Temperature Curable Coating Composition |
| 06/630,035 | 11/19/85 | 07/12/84 | Process For Low Temperature Curable Coating Composition |
| 06/757,037 | 05/20/86 | 07/19/85 | Surface Coating Process |
| 06/606,028 | 04/15/86 | 05/02/84 | Polyglycidamide Coating Compositions |
| 07/293,805 | 11/20/90 | 01/05/89 | Toner Composition Comprising Rosin Modified Styrene |
| | | | Acrylic Resin |
| 07/176,463 | 02/13/90 | 04/01/88 | Phenolic Foam |
| 07/199,419 | 06/50/90 | 05/27/88 | Hydroxy Functional Acrylamidomethyl Amino Resins |
| 07/199,559 | 06/50/90 | 05/27/88 | Polyglycidamide Coating Compositions |
| |)8/56/86 | 12/14/88 | Polyimide Laminates |
| |)3/26/91 | 03/29/89 | Process For The Preparation Of Polyglycidamides |
| | | 02/14/02 | Waterfast Ink Jet Inks Containing A UV Curable Resin |
| |)1/25/94 | 06/16/92 | Crosslinkable Resin Composition Comprising A |
| | | | Thermoplastic Resin |
| |)8/10/93 | 12/03/92 | Cured Phenolic Foams |
| |)2/22/94 | 06/11/93 | Crosslinkable Resin Composition Comprising A |
| | | | Thermoplastic Resin |
| | 14/29/97 | 10/10/95 | Liquid Hardeners For Soil Grouting Formulations |
| | 14/15/97 | 10/27/95 | Polymeric Flow Modifiers |
| Λ | 19/30/97 | 03/04/96 | Water Based Dimethyl Ester Cleaning Solution |
| | | 10/21/97 | Foaming-Resistant Hydrocarbon Oil Compositions |
| | .0/15/02 | 05/04/01 | Polyoxazoline Compounds And Their Use In Surface |
| - | | | Coatings |
| 6 | 19/12/00 | 09/25/98 | Non-Sag Liquid Application Method |
| 2. | 15/21/02 | 03/22/99 | Polymerization Process |
| a 1 | 2/18/01 | 04/03/00 | Low Gloss Coatings |
| P | | 01/24/01 | Environmentally Safe Paint Stripper |
| | | 02/14/01 | Alkoxymethyl Melamine Crosslinkers |
| | | 04/08/02 | Polymerization Process |
| | | 05/10/02 | Process For Improving Water-Whitening Resistance of |
| | | | Sensitive Adhesive |
| | | 05/23/02 | Process For Improving Water-Whitening Resistance of |
| | | | |

Der back

RECORDED: 05/02/2003

4,582,894 4,971,881

4,900,759 4,931,536

4,931,537